## HEF4794B <br> 8-stage shift-and-store register LED driver

Rev. 7 - 16 November 2011
Product data sheet

## 1. General description

The HEF4794B is an 8-stage serial shift register. It has a storage latch associated with each stage for strobing data from the serial input ( $D$ ) to the parallel LED driver outputs (QP0 to QP7). Data is shifted on the positive-going clock (CP) transitions. The data in each shift register stage is transferred to the storage register when the strobe input (STR) is HIGH. Data in the storage register appears at the outputs whenever the output enable input (OE) signal is HIGH.

Two serial outputs (QS1 and QS2) are available for cascading a number of HEF4794B devices. Serial data is available at QS1 on positive-going clock edges to allow high-speed operation in cascaded systems with a fast clock rise time. The same serial data is available at QS2 on the next negative going clock edge. This is used for cascading HEF4794B devices when the clock has a slow rise time.

It operates over a recommended $\mathrm{V}_{\mathrm{DD}}$ power supply range of 3 V to 15 V referenced to $\mathrm{V}_{\mathrm{SS}}$ (usually ground). Unused inputs must be connected to $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{SS}}$, or another input.

## 2. Features and benefits

- Fully static operation
- $5 \mathrm{~V}, 10 \mathrm{~V}$, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
- Complies with JEDEC standard JESD 13-B


## 3. Ordering information

Table 1. Ordering information All types operate from $-40{ }^{\circ} \mathrm{C}$ to $+125{ }^{\circ} \mathrm{C}$.

| Type number | Package |  |  |
| :--- | :--- | :--- | :--- |
|  | Name | Description | Version |
| HEF4794BP | DIP16 | plastic dual in-line package; 16 leads $(300$ mil $)$ | SOT38-4 |
| HEF4794BT | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |

## 4. Functional diagram



Fig 1. Logic symbol


Fig 2. Functional diagram


Fig 3. Logic diagram

## 5. Pinning information

### 5.1 Pinning



Fig 4. Pin configuration

### 5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
| :--- | :--- | :--- |
| D | 2 | serial input |
| QP0 to QP7 | $4,5,6,7,14,13,12,11$ | parallel output |
| QS1 | 9 | serial output |
| QS2 | 10 | serial output |
| CP | 3 | clock input |
| STR | 1 | strobe input |
| OE | 15 | output enable input |
| $V_{\text {DD }}$ | 16 | supply voltage |
| $V_{S S}$ | 8 | ground $(0 \mathrm{~V})$ |

## 6. Functional description

Table 3. Function table[1]

| Input |  |  |  |  |  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :---: |
| CP | OE | STR | D | Parallel output |  | Serial output |  |  |
| $\uparrow$ | L | X | XP0 | QPn | QS1[2] | QS2[3] |  |  |
| $\downarrow$ | L | X | X | Z | Z | n.c. | Q7S |  |
| $\uparrow$ | H | L | X | no change | no change | Q6S | no change |  |
| $\uparrow$ | H | H | L | Z | QPn -1 | Q6S | no change |  |
| $\uparrow$ | H | H | H | L | QPn -1 | Q6S | no change |  |
| $\downarrow$ | H | H | H | no change | no change | no change | Q7S |  |

[1] $\mathrm{H}=\mathrm{HIGH}$ voltage level; $L=$ LOW voltage level; $\mathrm{X}=$ don't care; $\mathrm{Z}=$ high-impedance OFF-state; $\uparrow=$ LOW-to-HIGH clock transition; $\downarrow=$ HIGH-to-LOW clock transition.
[2] Q6S = the data in register stage 6 before the LOW to HIGH clock transition.
[3] Q7S = the data in register stage 7 before the HIGH to LOW clock transition.


Fig 5. Timing diagram

## 7. Limiting values

Table 4. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {DD }}$ | supply voltage |  | -0.5 | +18 | V |
| $\mathrm{I}_{\text {IK }}$ | input clamping current | $\mathrm{V}_{1}<-0.5 \mathrm{~V}$ or $\mathrm{V}_{1}>\mathrm{V}_{\mathrm{DD}}+0.5 \mathrm{~V}$ | - | $\pm 10$ | mA |
| $V_{1}$ | input voltage |  | -0.5 | $V_{D D}+0.5$ | V |
| $\mathrm{l}_{\text {OK }}$ | output clamping current | QSn outputs; $\mathrm{V}_{\mathrm{O}}<-0.5 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{O}}>\mathrm{V}_{\mathrm{DD}}+0.5 \mathrm{~V}$ | - | $\pm 10$ | mA |
|  |  | QPn outputs; $\mathrm{V}_{\mathrm{O}}<-0.5 \mathrm{~V}$ | - | 40 | mA |
| 1 | input leakage current |  | - | $\pm 10$ | mA |
| Io | output current | QSn outputs | - | $\pm 10$ | mA |
|  |  | QPn outputs | - | 40 | mA |
| $\mathrm{T}_{\text {stg }}$ | storage temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {amb }}$ | ambient temperature |  | -40 | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{P}_{\text {tot }}$ | total power dissipation | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |
|  |  | DIP16 package | [1] - | 750 | mW |
|  |  | SO16 package | [2] - | 500 | mW |
| P | power dissipation | per output | - | 100 | mW |

[1] For DIP16 package: $P_{\text {tot }}$ derates linearly with $12 \mathrm{~mW} / \mathrm{K}$ above $70^{\circ} \mathrm{C}$.
[2] For SO16 package: $\mathrm{P}_{\text {tot }}$ derates linearly with $8 \mathrm{~mW} / \mathrm{K}$ above $70^{\circ} \mathrm{C}$.

## 8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions |  | Min | Max |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{DD}}$ | supply voltage |  | 3 | 15 | Vnit |
| $\mathrm{V}_{\mathrm{I}}$ | input voltage |  | 0 | $\mathrm{~V}_{\mathrm{DD}}$ | V |
| $\mathrm{T}_{\text {amb }}$ | ambient temperature | in free air | -40 | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\Delta \mathrm{t} / \Delta \mathrm{V}$ | input transition rise and fall rate | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ | - | 3.75 | $\mu \mathrm{~s} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ | - | 0.5 | $\mu \mathrm{~s} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ | - | 0.08 | $\mu \mathrm{~s} / \mathrm{V}$ |

## 9. Static characteristics

Table 6. Static characteristics
$V_{S S}=0 V ; V_{I}=V_{S S}$ or $V_{D D}$; unless otherwise specified.

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\mathrm{amb}}=85^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\text {amb }}=125^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Max | Min | Max | Min | Max | Min | Max |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\left\|\mathrm{l}_{\mathrm{O}}\right\|<1 \mu \mathrm{~A}$ | 5 V | 3.5 | - | 3.5 | - | 3.5 | - | 3.5 | - | V |
|  |  |  | 10 V | 7.0 | - | 7.0 | - | 7.0 | - | 7.0 | - | V |
|  |  |  | 15 V | 11.0 | - | 11.0 | - | 11.0 | - | 11.0 | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\left\|\mathrm{l}_{\mathrm{O}}\right\|<1 \mu \mathrm{~A}$ | 5 V | - | 1.5 | - | 1.5 | - | 1.5 | - | 1.5 | V |
|  |  |  | 10 V | - | 3.0 | - | 3.0 | - | 3.0 | - | 3.0 | V |
|  |  |  | 15 V | - | 4.0 | - | 4.0 | - | 4.0 | - | 4.0 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | QSn outputs;$\left\|\mathrm{I}_{\mathrm{O}}\right\|<1 \mu \mathrm{~A}$ | 5 V | 4.95 | - | 4.95 | - | 4.95 | - | 4.95 | - | V |
|  |  |  | 10 V | 9.95 | - | 9.95 | - | 9.95 | - | 9.95 | - | V |
|  |  |  | 15 V | 14.95 | - | 14.95 | - | 14.95 | - | 14.95 | - | V |
| $\mathrm{V}_{\mathrm{OL}}$ | LOW-level output voltage | QSn outputs;$\left\|l_{\mathrm{O}}\right\|<1 \mu \mathrm{~A}$ | 5 V | - | 0.05 | - | 0.05 | - | 0.05 | - | 0.05 | V |
|  |  |  | 10 V | - | 0.05 | - | 0.05 | - | 0.05 | - | 0.05 | V |
|  |  |  | 15 V | - | 0.05 | - | 0.05 | - | 0.05 | - | 0.05 | V |
|  |  | QPn outputs;$\|\mathrm{I} \mathrm{O}\|<20 \mathrm{~mA}$ | 5 V | - | 0.75 | - | 0.75 | - | 1.5 | - | 1.5 | V |
|  |  |  | 10 V | - | 0.75 | - | 0.75 | - | 1.5 | - | 1.5 | V |
|  |  |  | 15 V | - | 0.75 | - | 0.75 | - | 1.5 | - | 1.5 | V |
| IOH | HIGH-level output current | QSn outputs |  |  |  |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{O}}=2.5 \mathrm{~V}$ | 5 V | - | -1.7 | - | -1.4 | - | -1.1 | - | -1.1 | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=4.6 \mathrm{~V}$ | 5 V | - | -0.64 | - | -0.5 | - | -0.36 | - | -0.36 | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=9.5 \mathrm{~V}$ | 10 V | - | -1.6 | - | -1.3 | - | -0.9 | - | -0.9 | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=13.5 \mathrm{~V}$ | 15 V | - | -4.2 | - | -3.4 | - | -2.4 | - | -2.4 | mA |
| $\mathrm{l}_{\mathrm{OL}}$ | LOW-level output current | QSn outputs |  |  |  |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{O}}=0.4 \mathrm{~V}$ | 5 V | 0.64 | - | 0.5 | - | 0.36 | - | 0.36 | - | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ | 10 V | 1.6 | - | 1.3 | - | 0.9 | - | 0.9 | - | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=1.5 \mathrm{~V}$ | 15 V | 4.2 | - | 3.4 | - | 2.4 | - | 2.4 | - | mA |
| 1 | input leakage current |  | 15 V | - | $\pm 0.1$ | - | $\pm 0.1$ | - | $\pm 1.0$ | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| loz | OFF-state output current | QPn output is HIGH;$V_{O}=15 \mathrm{~V}$ | 5 V | - | 2 | - | 2 | - | 15 | - | 15 | $\mu \mathrm{A}$ |
|  |  |  | 10 V | - | 2 | - | 2 | - | 15 | - | 15 | $\mu \mathrm{A}$ |
|  |  |  | 15 V | - | 2 | - | 2 | - | 15 | - | 15 | $\mu \mathrm{A}$ |
| $I_{\text {DD }}$ | supply current | $\mathrm{I}_{0}=0 \mathrm{~A}$ | 5 V | - | 5 | - | 5 | - | 150 | - | 150 | $\mu \mathrm{A}$ |
|  |  |  | 10 V | - | 10 | - | 10 | - | 300 | - | 300 | $\mu \mathrm{A}$ |
|  |  |  | 15 V | - | 20 | - | 20 | - | 600 | - | 600 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{1}$ | input capacitance |  | - | - | - | - | - | 7.5 | - | - | - | pF |

## 10. Dynamic characteristics

Table 7. Dynamic characteristics
$V_{S S}=0 \mathrm{~V} ; T_{\text {amb }}=25^{\circ} \mathrm{C}$ unless otherwise specified. For test circuit, see Figure 10.

| Symbol | Parameter | Conditions | VD |  | Extrapolation formula | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {PHL }}$ | HIGH to LOW propagation delay | CP to QS1; see Figure 6 | 5 V | [1] | $132 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 160 | 320 | ns |
|  |  |  | 10 V |  | $53 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 65 | 130 | ns |
|  |  |  | 15 V |  | $37 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 45 | 90 | ns |
|  |  | CP to QS2; see Figure 6 | 5 V |  | $92 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 120 | 240 | ns |
|  |  |  | 10 V |  | $39 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 50 | 100 | ns |
|  |  |  | 15 V |  | $32 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 40 | 80 | ns |
| $t_{\text {PLH }}$ | LOW to HIGH propagation delay | CP to QS1; see Figure 6 | 5 V | [1] | $102 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 130 | 260 | ns |
|  |  |  | 10 V |  | $44 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 55 | 110 | ns |
|  |  |  | 15 V |  | $32 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 40 | 80 | ns |
|  |  | CP to QS2; see Figure 6 | 5 V |  | $102 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 130 | 260 | ns |
|  |  |  | 10 V |  | $49 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 60 | 120 | ns |
|  |  |  | 15 V |  | $37 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 45 | 90 | ns |
| $t_{\text {PzL }}$ | OFF-state to LOW propagation delay | CP to QPn; see Figure 6 | 5 V |  |  | - | 240 | 480 | ns |
|  |  |  | 10 V |  |  | - | 80 | 160 | ns |
|  |  |  | 15 V |  |  | - | 55 | 110 | ns |
|  |  | STR to QPn; see Figure 7 | 5 V |  |  | - | 140 | 280 | ns |
|  |  |  | 10 V |  |  | - | 70 | 140 | ns |
|  |  |  | 15 V |  |  | - | 55 | 110 | ns |
| $t_{\text {PLZ }}$ | LOW to OFF-state propagation delay | CP to QPn; see Figure 6 | 5 V |  |  | - | 170 | 340 | ns |
|  |  |  | 10 V |  |  | - | 75 | 150 | ns |
|  |  |  | 15 V |  |  | - | 60 | 120 | ns |
|  |  | STR to QPn; see Figure 7 | 5 V |  |  | - | 100 | 200 | ns |
|  |  |  | 10 V |  |  | - | 40 | 100 | ns |
|  |  |  | 15 V |  |  | - | 35 | 70 | ns |
| $\mathrm{t}_{\text {en }}$ | enable time | OE to QPn; see Figure 8 | 5 V | [2] |  | - | 100 | 200 | ns |
|  |  |  | 10 V |  |  | - | 55 | 110 | ns |
|  |  |  | 15 V |  |  | - | 50 | 100 | ns |
| $\mathrm{t}_{\text {dis }}$ | disable time | OE to QPn; see Figure 8 | 5 V | [2] |  | - | 80 | 160 | ns |
|  |  |  | 10 V |  |  | - | 40 | 80 | ns |
|  |  |  | 15 V |  |  | - | 30 | 60 | ns |
| $t_{t}$ | transition time | $\begin{aligned} & \text { QS1, QS2; } \\ & \text { see Figure } 6 \end{aligned}$ | 5 V | [1] | $35 \mathrm{~ns}+(1.00 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 85 | 170 | ns |
|  |  |  | 10 V | [3] | $19 \mathrm{~ns}+(0.42 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 40 | 80 | ns |
|  |  |  | 15 V |  | $16 \mathrm{~ns}+(0.28 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 30 | 60 | ns |

Table 7. Dynamic characteristics ...continued
$V_{S S}=0 \mathrm{~V} ; T_{\text {amb }}=25^{\circ} \mathrm{C}$ unless otherwise specified. For test circuit, see Figure 10.

| Symbol | Parameter | Conditions | VD | Extrapolation formula | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| tw | pulse width | CP; LOW and HIGH; see Figure 6 | 5 V |  | 60 | 30 | - | ns |
|  |  |  | 10 V |  | 30 | 15 | - | ns |
|  |  |  | 15 V |  | 24 | 12 | - | ns |
|  |  | STR; HIGH; see Figure 7 | 5 V |  | 80 | 40 | - | ns |
|  |  |  | 10 V |  | 60 | 30 | - | ns |
|  |  |  | 15 V |  | 24 | 12 | - | ns |
| $\mathrm{t}_{\text {su }}$ | set-up time | D to CP; <br> see Figure 9 | 5 V |  | 60 | 30 | - | ns |
|  |  |  | 10 V |  | 20 | 10 | - | ns |
|  |  |  | 15 V |  | 15 | 5 | - | ns |
| $t_{\text {h }}$ | hold time | D to CP; see Figure 9 | 5 V |  | +5 | -15 | - | ns |
|  |  |  | 10 V |  | 20 | 5 | - | ns |
|  |  |  | 15 V |  | 20 | 5 | - | ns |
| $\mathrm{f}_{\text {clk (max) }}$ | maximum clock frequency | CP; see Figure 6 | 5 V |  | 5 | 10 | - | MHz |
|  |  |  | 10 V |  | 11 | 22 | - | MHz |
|  |  |  | 15 V |  | 14 | 28 | - | MHz |

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown ( $\mathrm{C}_{\mathrm{L}}$ in pF ).
[2] $t_{e n}$ is the same as $t_{P Z L}$ and $t_{d i s}$ is the same as $t_{P L Z}$
[3] $t_{t}$ is the same as $t_{T L H}$ and $t_{T H L}$

Table 8. Dynamic power dissipation
$P_{D}$ can be calculated from the formulas shown. $V_{S S}=0 \mathrm{~V} ; t_{r}=t_{f} \leq 20 \mathrm{~ns} ; T_{\text {amb }}=25^{\circ} \mathrm{C}$.

| Symbol | Parameter | $\mathrm{V}_{\mathrm{DD}}$ | Typical formula | Where |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{P}_{\mathrm{D}}$ | dynamic power dissipation | 5 V | $\mathrm{P}_{\mathrm{D}}=1200 \times \mathrm{f}_{\mathrm{i}}+\Sigma\left(\mathrm{f}_{0} \times \mathrm{C}_{\mathrm{L}}\right) \times \mathrm{V}_{\text {DD }}{ }^{2} \mu \mathrm{~W}$ | $\mathrm{f}_{\mathrm{i}}=$ input frequency in MHz ; |
|  |  | 10 V | $\mathrm{P}_{\mathrm{D}}=5550 \times \mathrm{f}_{\mathrm{i}}+\Sigma\left(\mathrm{f}_{\mathrm{o}} \times \mathrm{C}_{\mathrm{L}}\right) \times \mathrm{V}_{\text {DD }}{ }^{2} \mu \mathrm{~W}$ | $\mathrm{f}_{\mathrm{o}}=$ output frequency in MHz ; |
|  |  | 15 V | $P_{D}=15000 \times f_{i}+\Sigma\left(f_{0} \times C_{L}\right) \times V_{D D^{2}} \mu \mathrm{~W}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=\text { output load capacitance in } \mathrm{pF} ; \\ & \Sigma\left(\mathrm{f}_{\mathrm{o}} \times \mathrm{C}_{\mathrm{L}}\right)=\text { sum of the outputs; } \\ & \mathrm{V}_{\mathrm{DD}}=\text { supply voltage in } \mathrm{V} \text {. } \end{aligned}$ |

## 11. Waveforms



Parallel output measurement points are given in Table 9.
$\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ are typical output voltage levels that occur with the output load.
Fig 6. Propagation delay clock (CP) to output (QPn, QS1, QS2), clock pulse width and maximum clock frequency

Table 9. Measurement points

| Supply | Input | Output |  |  |
| :--- | :--- | :--- | :--- | :--- |
| $\mathbf{V}_{\mathbf{D D}}$ | $\mathbf{V}_{\mathbf{M}}$ | $\mathbf{V}_{\mathbf{M}}$ | $\mathbf{V}_{\mathbf{X}}$ | $\mathbf{V}_{\mathbf{Y}}$ |
| 5 V to 15 V | $0.5 \mathrm{~V}_{\mathrm{DD}}$ | $0.5 \mathrm{~V}_{\mathrm{DD}}$ | $0.1 \mathrm{~V}_{\mathrm{O}}$ | $0.9 \mathrm{~V}_{\mathrm{O}}$ |



Measurement points are given in Table 9.
$V_{O L}$ is the typical output voltage level that occurs with the output load.
Fig 7. Strobe (STR) to output (QPn) propagation delays and the strobe pulse width


Measurement points are given in Table 9.
$\mathrm{V}_{\mathrm{OL}}$ is the typical output voltage level that occurs with the output load.
Fig 8. Enable and disable times for input OE


Measurement points are given in Table 9
The shaded areas indicate when the input is permitted to change for predictable output performance.
$\mathrm{V}_{\mathrm{OL}}$ is the typical output voltage level that occurs with the output load.
Fig 9. Set-up and hold times for the data input (D)


Test data is given in Table 10.
Definitions for test circuit:
DUT - Device Under Test.
$\mathrm{R}_{\mathrm{L}}=$ Load resistance.
$C_{L}=$ load capacitance
$\mathrm{R}_{\mathrm{T}}=$ Termination resistance should be equal to output impedance of $Z_{o}$ of the pulse generator. $\mathrm{V}_{\mathrm{EXT}}=$ External voltage for measuring switching times.

Fig 10. Test circuit for measuring switching times

Table 10. Test data

| Supply | Input |  | $\mathrm{V}_{\text {EXT }}$ |  | Load |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {DD }}$ | V | $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | $\mathrm{t}_{\text {PLZ }}, \mathrm{t}_{\text {PZL }}$ | $\mathbf{t}_{\text {PLH }}, \mathrm{t}_{\text {PHL }}$ | $\mathrm{C}_{\mathrm{L}}$ | $\mathbf{R}_{\mathrm{L}}$ |
| 5 V to 15 V | $V_{\text {DD }}$ | $\leq 20 \mathrm{~ns}$ | $V_{\text {DD }}$ | open | 50 pF | $1 \mathrm{k} \Omega$ |

## 12. Application information

Application example: serial-to-parallel data converting LED drivers.


Fig 11. Serial-to-parallel converting LED drivers

## 13. Package outline



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | $\mathbf{A}$ <br> $\mathbf{m a x}$. | $\mathbf{A}_{\mathbf{1}}$ <br> $\mathbf{m i n}$. | $\mathbf{A}_{\mathbf{2}}$ <br> $\mathbf{m a x}$. | $\mathbf{b}$ | $\mathbf{b}_{\mathbf{1}}$ | $\mathbf{b}_{\mathbf{2}}$ | $\mathbf{c}$ | $\mathbf{D}^{(\mathbf{1})}$ | $\mathbf{E}^{\mathbf{1})}$ | $\mathbf{e}$ | $\mathbf{e}_{\mathbf{1}}$ | $\mathbf{L}$ | $\mathbf{M}_{\mathbf{E}}$ | $\mathbf{M}_{\mathbf{H}}$ | $\mathbf{w}$ | $\mathbf{Z}^{(\mathbf{1})}$ <br> $\mathbf{m a x}$. |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 4.2 | 0.51 | 3.2 | 1.73 | 0.53 | 1.25 | 0.36 | 19.50 | 6.48 | 2.54 | 7.62 | 3.60 | 8.25 | 10.0 | 0.254 | 0.76 |
|  |  |  | 1.30 | 0.38 | 0.85 | 0.23 | 18.55 | 6.20 |  |  |  |  |  |  |  |  |
| inches | 0.17 | 0.02 | 0.13 | 0.068 | 0.021 | 0.049 | 0.014 | 0.77 | 0.26 | 0.8 | 0.3 | 0.14 | 0.32 | 0.39 | 0.3 |  |
|  |  |  | 0.051 | 0.015 | 0.033 | 0.009 | 0.73 | 0.24 | 0.1 | 0.3 | 0.12 | 0.31 | 0.33 | 0.03 |  |  |

Note

1. Plastic or metal protrusions of 0.25 mm ( 0.01 inch ) maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  | $-95-01-14$ |
| SOT38-4 |  |  |  |  | - |  |

Fig 12. Package outline SOT38-4 (DIP16)


DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | $\begin{gathered} \mathrm{A} \\ \max . \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $D^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $\mathrm{L}_{\mathrm{p}}$ | Q | v | w | y | $Z^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1.75 | $\begin{aligned} & 0.25 \\ & 0.10 \end{aligned}$ | $\begin{aligned} & 1.45 \\ & 1.25 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.49 \\ & 0.36 \end{aligned}$ | $\begin{aligned} & 0.25 \\ & 0.19 \end{aligned}$ | $\begin{gathered} 10.0 \\ 9.8 \end{gathered}$ | $\begin{aligned} & 4.0 \\ & 3.8 \end{aligned}$ | 1.27 | $\begin{aligned} & 6.2 \\ & 5.8 \end{aligned}$ | 1.05 | $\begin{aligned} & 1.0 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 0.7 \\ & 0.6 \end{aligned}$ | 0.25 | 0.25 | 0.1 | $\begin{aligned} & 0.7 \\ & 0.3 \end{aligned}$ | $8^{\circ}$ |
| inches | 0.069 | $\begin{aligned} & 0.010 \\ & 0.004 \end{aligned}$ | $\begin{aligned} & 0.057 \\ & 0.049 \end{aligned}$ | 0.01 | $\begin{aligned} & 0.019 \\ & 0.014 \end{aligned}$ | $\begin{array}{l\|} \hline 0.0100 \\ 0.0075 \end{array}$ | $\begin{aligned} & 0.39 \\ & 0.38 \end{aligned}$ | $\begin{aligned} & 0.16 \\ & 0.15 \end{aligned}$ | 0.05 | $\begin{array}{\|l\|} \hline 0.244 \\ 0.228 \\ \hline \end{array}$ | 0.041 | $\begin{array}{\|l\|} \hline 0.039 \\ 0.016 \end{array}$ | $\begin{aligned} & 0.028 \\ & 0.020 \end{aligned}$ | 0.01 | 0.01 | 0.004 | $\begin{aligned} & \hline 0.028 \\ & 0.012 \end{aligned}$ | $0^{\circ}$ |

Note

1. Plastic or metal protrusions of 0.15 mm ( 0.006 inch ) maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT109-1 | 076E07 | MS-012 |  | $\square$ | $\begin{aligned} & 99-12-27 \\ & 03-02-19 \end{aligned}$ |

Fig 13. Package outline SOT109-1 (SO16)

## 14. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| :---: | :---: | :---: | :---: | :---: |
| HEF4794B v. 7 | 20111116 | Product data sheet | - | HEF4794B v. 6 |
| Modifications: | - Section Applications removed <br> - Table 6: <br> - $\mathrm{I}_{\mathrm{OH}}$ minimum values changed to maximum <br> - added the unit pF for $\mathrm{C}_{1}$ |  |  |  |
| HEF4794B v. 6 | 20100901 | Product data sheet | - | HEF4794B v. 5 |
| HEF4794B v. 5 | 20100402 | Product data sheet | - | HEF4794B v. 4 |
| HEF4794B v. 4 | 20091222 | Product data sheet | - | HEF4794B v. 3 |
| HEF4794B v. 3 | 20080812 | Product data sheet | - | HEF4794B v. 2 |
| HEF4794B v. 2 | 19990630 | Product specification | - | HEF4794B v. 1 |
| HEF4794B v. 1 | 19940701 | Product specification | - | - |

## 15. Legal information

### 15.1 Data sheet status

| Document status $[1][2]$ | Product status $[3]$ | Definition |
| :--- | :--- | :--- |
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
2] The term 'short data sheet' is explained in section "Definitions"
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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